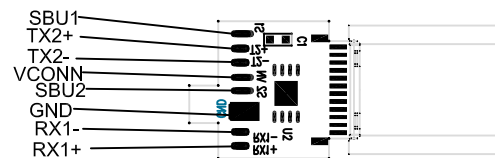
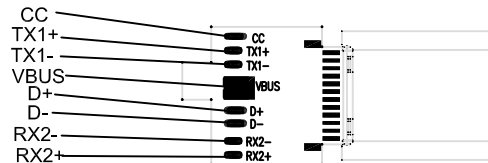


1. Test:
  1. 100% short circuit, open circuit and dislocation test;
  2. conduction impedance:  $3 \omega$  (Max)
  3. field measurement: A.) field measurement C correct reverse identification hard disk  
B.) Whether the measured disk transmission speed reaches USB3.1, The read/write data must be at least 300MB/S

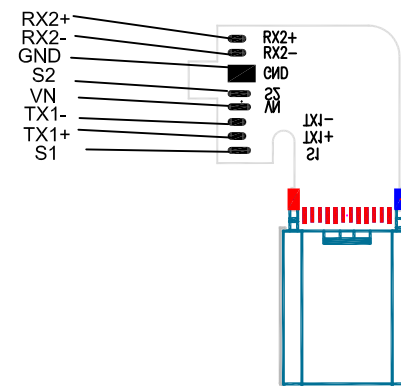
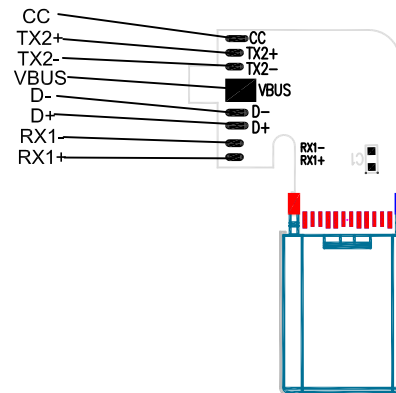
⑫	USB TYPE C on Meta Can	1	pcs
⑪	USB TYPE C Under the Meta Can	1	pcs
⑩	Wire clip 30+32+26+34AWG	2	pcs
⑨	High temperature adhesive tape	0.07	M
⑧	Double conductive copper foil	0.13	M
⑦	USB TYPE C on Meta Can	1	pcs
⑥	USB TYPE C Under the Meta Can	1	pcs
⑤	45P PVC black	12	g
④	Low pressure forming material ~	1	g
③	USB 3.1 TYPE C 90° bending PCB+SMT+Nickel plating	1	pcs
②	USB 3.1 TYPE C PCB+SMT+VL152C+Nickel plating	1	pcs
①	USB3.1 [30AWG (7/0.1TC)+EAM]*4P+[32AWG (7/0.08TC)+EA]*1P+26AWG (7/0.16TC)*2C+[34AWG (7/0.06TC)+A]*3C+34AWG (7/0.06TC)*1C+A2EB (24/11/0.06TC 85%) OD: 5.2MM black	1.01	M
NO	ITEM DESCRIPTION	Q'TY	UNIT

REV.	ECN NO	DESCRIPTION	DATE	NAME	
	TOLERANCE				
	INCHES				M/M
	.X	.015			.30
		.XX	.010	.10	TITLE:
		.XXX	.005	.05	USB3.1 CM TO CM(E-Mark) 3A 5G L=1M
DRAWN BY	Shijie	CUSTOMER :			
CHECK BY		CUSTOMER P/N :	AC7406		
APPD BY		SCALE	NONE	DRAWING NO.:	REV. A1
		UNIT	MM		
		DATE	2021.11.15		1/3

P1



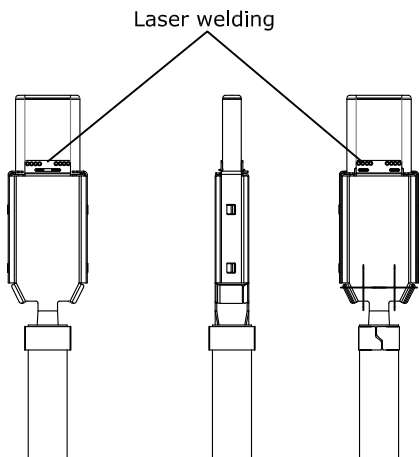
P2



4、Pin Assignment:

PCB信号	P1	P2
CC	A5	A5 CC
D+	A6	A6 D+
D-	A7	A7 D-
SBU1	A8	B8 SBU2
VCONN	B5	B5 VCONN
SBU2	B8	A8 SBU1
SSTX1+	A2	B11 SSRX1+
SSTX1-	A3	B10 SSRX1-
SSRX2+	A11	B2 SSTX2+
SSRX2-	A10	B3 SSTX2-
SSTX2+	B2	A11 SSRX2+
SSTX2-	B3	A10 SSRX2-
SSRX1+	B11	A2 SSTX1+
SSRX1-	B10	A3 SSTX1-
GND(A1,A12,B1,B12)		A1,A12,B1,B12
Shell		Shell
VBUS (A4,A9,B4,B9)		A4,A9,B4,B9

(26AWG\*2C)



REV.	ECN NO	DESCRIPTION	DATE	NAME
		TOLERANCE INCHES M/M		
.X	.015	.30		
.XX	.010	.10		
.XXX	.005	.05	TITLE: USB3.1 CM TO CM(E-Mark) 3A 5G L=1M	
DRAWN BY	Shijie	CUSTOMER :		
CHECK BY		CUSTOMER P/N :	AC7406	
APPD BY		SCALE	NONE	DRAWING NO.:
		UNIT	MM	
		DATE	2021.11.15	REV. A1
				2/3

NO	ITEM	DESCRIPTION	Q'TY	UNIT